



# Product Change Notice

(PCN No.: 01-06)

Customer: *All*

IXYS product type: *All types in ISOPLUS-DIL package, namely:  
GWM220-004P3, GWM160-0055P3, GWM120-0075P3 and GWM70-01P2*

Description of change: *The step on the back side of the package will be removed (DCB side) and will be completely filled with mold material, see attached drawing. Further the pin length will be changed from 17,5mm to 14mm.*

Reason for change: *Improved ruggedness of package*

Identification: *By forth digit in the date code, letter A will be changed into letter B.*

Schedule of change: *Plan for completion is CW 16 2006. Both versions may be delivered during transition time.*

Influence on reliability: *None*

Internal reference: *ÄA142/05*

In case of any question, please contact

Initiator	Title/Function	Date	e-mail
<i>Laschek-Enders</i>	<i>MP2 / Product marketing</i>	<i>25.01.2006</i>	<i>a.laschek-enders@ixys.de</i>

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## Customer response:

(please fill in and return by e-mail, fax or mail within 4 weeks)

for further questions / information Company: \_\_\_\_\_

please comment Name & Position: \_\_\_\_\_

Phone / Fax No.: \_\_\_\_\_

Note: **Written** response or **written** acknowledgement with statement of approval criteria, must be received within thirty (30) days of the date of this PCN or IXYS will consider this change approved.

Comments: \_\_\_\_\_

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